



808nm 2000mW CW VCSEL Diode

VCx-808C2WA



Description

The Lasermate VCx-808C2WA is an 808nm wavelength, 2000mW output power, CW operating mode, Vertical Cavity Surface Emitting Laser (VCSEL) diode. Available in different package types, the VCSEL features single longitudinal mode, low wavelength drift, and easy collimation. Ideal for 3D sensor, Lidar, IR illumination, medical, Solid state pump source, range finder sensor.

Features

- 808nm VCSEL Diode
- Output power: 2000mW
- Single longitudinal mode
- Low wavelength drift
- Oxide isolation technology
- Small emission area
- Easy to collimate

Applications

- 3D sensor
- Lidars
- IR illumination
- Range finder sensor
- Solid-state pump source
- Medical application

Product Overview

The following table lists the available part numbers, as well as the package type of each of the part numbers.

Part Number	Package
VC35A-808C2WA	3535 Package, Substrate AlN
VC70C-808C2WA	7060 Package, Substrate CuAg

Specifications

Absolute Maximum Ratings				
Parameters	Symbol	Rating	Unit	Conditions
Case Operating Temperature	Top	-40 to 85	°C	
Storage Temperature	Tstg	-40 to 105	°C	
Reflow Soldering Temperature	Tsol	260	°C	10 seconds
Reverse Voltage	Vr	5	V	
Maximum Continuous Current	I _{max}	6	A	
ESD Exposure (Human Body) Model	ESD	2K-4K (Class 2)	V	
ESD Exposure (Machine) Model	ESD	200-400 (Class B)	V	

Notes:

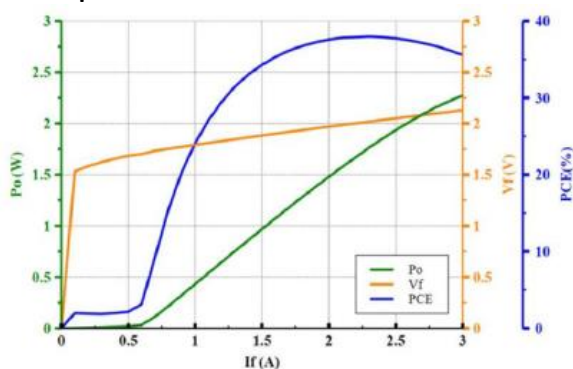
- Stresses greater than those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions above those indicated in the operations section for expanded periods of time may affect reliability.
- In its maximum rating diode laser operation could damage its performance or cause potential safety hazard such as equipment failure.
- Electrostatic discharge is the main reason for laser fault of the diode. Take effective precautions against ESD. When dealing with laser diodes, use wrist strap, grounding work surface and strict antistatic technology.

Electro-Optical Characteristics (T _{op} =25°C, CW mode)							
Parameters	Symbol	Min.	Typ.	Max.	Unit	Conditions	
Optical Output Power	P _o	-	2.0	-	W	I _F =2.6A	
Threshold Current	I _{th}	-	0.6	-	A		
Forward Pulse Current	I _F	-	2.6	-	A		
Power Conversion Efficiency	PCE	-	37	-	%		
Slope Efficiency	η	-	0.8	-	W/A		
Peak Wavelength	λ _P	800	808	816	nm	P _o =2.0W	
Forward Voltage	V _f	-	2.1	-	V	I _F =2.6A	
Emission Area		-	684x634		um ²		
Series Resistance	R _s	-	0.16	-	Ohm	I _F =2.6A	
Beam Angle	(1/e ²)	θ	-	25	-	Deg	I _F =2.6A
	FWHM		-	20	-		
Wavelength Temperature Drift	Δλ _P / ΔT	-	0.07	-	nm/°C	I _F =2.6A	
Soldering Temperature	Tsol			260	°C	10 seconds	
Substrate	AlN						

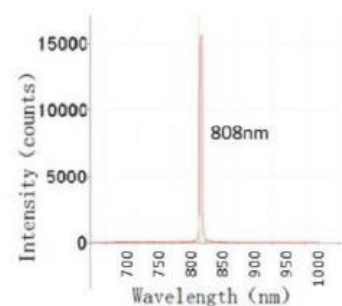
Note: Electro-optical characteristic with a package or diffuser would require further evaluation. Values are based on limited sample size and estimated values.

Typical Characteristics

LIV Graph

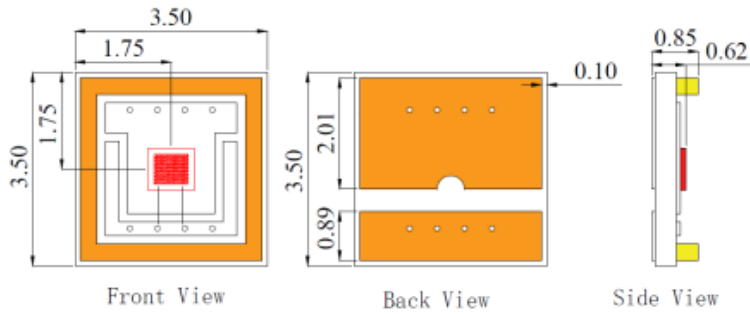


Intensity vs. Wavelength

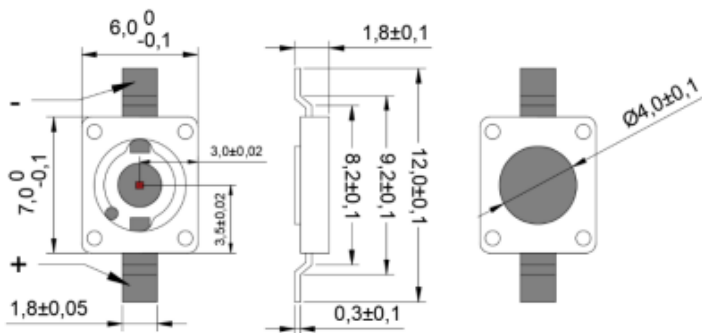


Outline Dimensions (unit: mm)

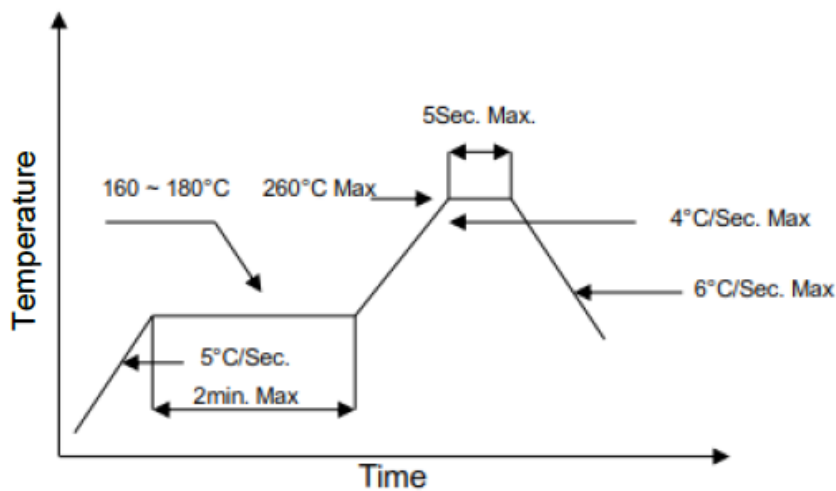
VC35A-808C2WA (3535 SMD Package, Substrate AlN)



VC70A-808C2WA (7060 SMD Package, Substrate CuAg)



SMT Reflow Soldering Curve



Note: Reflow soldering can be operated only one time. During the temperature ramp-up, no forces may be exerted on the LD which would deform or damage them. After soldering is completed, please do not process until the product temperature ramps down to room temperature.

Additional Notes

1. Please use solder paste to cure the laser diode.
2. Please make sure that the heat of VCSEL diode has been completely conducted to metal shell to avoid affecting the optical power output.
3. This VCSEL diode can be only used in constant voltage and current.
4. Please do not aim the laser at people or animals.
5. You may observe the laser spot through an image monitoring equipment.
6. Please do not touch VCSEL diode surface by naked hands or squeeze the sealant on VCSEL diode surface. It may cause wrong optical angle and distorted laser spot, and even damage the VCSEL diode.
7. Please use ceramic suction nozzle to absorb the VCSEL diode, so as to avoid VCSEL diode sticking to the nozzle.
8. Please add a 0.02s blowing action after locating the laser diode to aluminum substrate.
9. Specifications are subject to change without notice.



Lasermate Group, Inc.
19608 Camino De Rosa
Walnut, CA 91789 USA
Tel: (909)718-0999
Fax: (909)718-0998
sales@lasermate.com
www.lasermate.com